SN54ALS1035, SN74ALS1035 **HEX NONINVERTING BUFFERS** WITH OPEN-COLLECTOR OUTPUTS

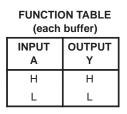
SDAS243A - APRIL 1982 - REVISED JANUARY 1995

- Noninverting Buffers With Open-Collector **Outputs**
- Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

These devices contain six independent noninverting buffers. They perform the Boolean function Y = A. The open-collector outputs require pullup resistors to perform correctly. They may be connected to other open-collector outputs to implement active-low wired-OR or active-high wired-AND functions. Open-collector devices are often used to generate higher VOH levels.

The SN54ALS1035 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS1035 is characterized for operation from 0°C to 70°C.



logic symbol[†]

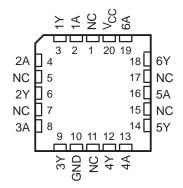
1 A	1	\diamond	2	1Y
1A	3	\sim	4	
2A	5	 	6	2Y
3A	9	 	8	3Y
4A	11		10	4Y
5A	13		12	5Y
6A				6Y

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

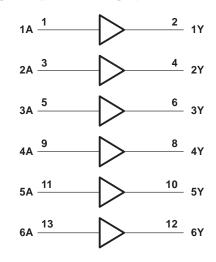
SN54ALS1035 J PACKAGE SN74ALS1035 D OR N PACKAGE (TOP VIEW)									
1A [1	14	V _{CC}						
1Y [2	13	6A						
2A [3	12	6Y						
2Y [4	11	5A						
3A [5	10	5Y						
3Y [6	9	4A						
GND [7	8	4Y						

SN54ALS1035 ... FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram (positive logic)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	
Off-state output voltage	
Operating free-air temperature range, T _A : SN54ALS1035	
SN74ALS1035	0°C to 70°C
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54ALS1035			SN74ALS1035			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
VOH	High-level output voltage			5.5			5.5	V
IOL	Low-level output current			12			24	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN	SN54ALS1035			SN74ALS1035		
FARAMETER	TES	TEST CONDITIONS		TYP‡	MAX	MIN	typ‡	MAX	UNIT
VIK	$V_{CC} = 4.5 V,$	II = -18 mA			-1.5			-1.5	V
Vol	V _{CC} = 4.5 V	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	v
VOL	VCC = 4.5 V	I _{OL} = 24 mA					0.35	0.5	v
IOH	$V_{CC} = 4.5 V,$	V _{OH} = 5.5 V			0.1			0.1	V
lj	V _{CC} = 5.5 V,	$V_{I} = 7 V$			0.1			0.1	mA
IН	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μA
١ _{IL}	V _{CC} = 5.5 V,	$V_I = 0.4 V$			-0.1			-0.1	mA
ІССН	$V_{CC} = 5.5 V,$	V _I = 4.5 V		3	6		3	6	mA
ICCL	$V_{CC} = 5.5 V,$	$V_{I} = 0$		8	14		8	14	mA

[‡] All typical values are at V_{CC} = 5 V, $T_A = 25^{\circ}C$.

switching characteristics (see Figure 1)

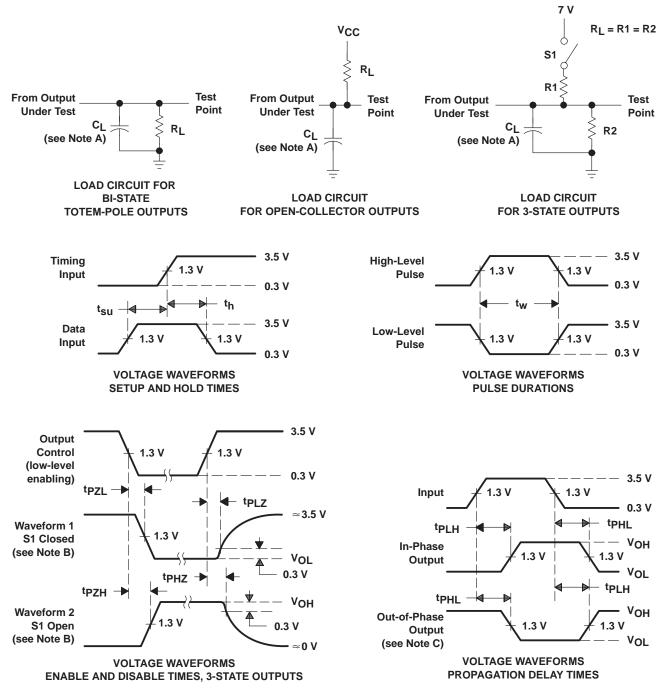
PARAMETER		FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5 V \text{ to } 5.5 V,$ $C_L = 50 \text{ pF},$ $R_L = 680 \Omega,$ $T_A = \text{MIN to MAX}$ SN54ALS1035 SN74ALS1035				UNIT
				MIN	MAX	MIN	MAX	
^t PLH			V	5	35	5	30	
tphl	-	A	Т	2	14	2	12	ns

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



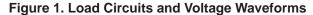
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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.





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